	AND TRADES OF PARTY AND TRADES OF PROPERTY	ATTORNEYS DOCKET NUMBER
(REV 10-94)	PARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	10921.111USWO
TRANSMITTAL LETTER		10921.111USWU
DESIGNATED/ELECTE	D OFFICE (DO/EO/US)	1
CONCERNING A FILIN	G UNDER 35 U.S.C. 371	
001,0212		U.S. APPLICATION NO. (If known, see 37 C.F.R. 1.5)
		UNKNO 1/0/030845
INTERNATIONAL APPLICATION NO.	INTERNATIONAL FILING DATE	PRIORITY DATE CLAIMED
PCT/JP00/04613	JULY 10, 2000	JULY 12, 1999
TITLE OF INVENTION		
PROCESS FOR PRODUCING ADHESIVE FOR FUS FABRIC CONTAINING THE ADHESIVE FOR FUSI	ION BONDING, ADHESIVE FOR FUSION BONDIN ON BONDING	IG OBTAINED BY THE PROCESS, AND ADHESIVE
APPLICANT(S) FOR DO/EO/US		
ARAKI, Eiichi; SUGIHARA, Norihiro; NAKAO, Kaio	chiro; MANABE, Hiroshi; TAKEI, Tooru	
Applicant herewith submits to the United States De	esignated/Elected Office (DO/EO/US) the following	g items and other information:
1 FX1 This is a FIRST submission of items con	acerning a filing under 35 U.S.C. 371.	
2 This is a SECOND or SUBSEOUE	NT submission of items concerning a filing under amination procedures (35 U.S.C. 371(f)) at any tin	35 U.S.C. 371. ne rather than delay
insting until the expiration of the ar	volicable time limit set in 35 U.S.C. 371(b) and PC	T Articles 22 and 39(1).
[X] A proper Demand for International Prelin	minary Examination was made by the 19th month	from the earliest claimed priority date.
5. [X] A copy of the International Application a	as filed (35 U.S.C. 371(c)(2))	
a. [] is transmitted herewith (rec	quired only if not transmitted by the International E	Bureau).
b. [X] has been transmitted by the Inte	ernational Bureau.	
c. [X] is not required, as the application. [X] A translation of the International Application.	on was filed in the United States Receiving Office (ation into English (35 U.S.C. 371(c)(2)).	(10,00)
ħ ·		/ //2/
7. [X] Amendments to the claims of the Interna	tional Application under PCT Article 19 (35 U.S.C equired only if not transmitted by the International	. 371(c)(3)) Bureau).
h [] have been transmitted by t	he International Bureau.	
c. [] have not been made; howe	ever, the time limit for making such amendments h	as NOT expired.
d. [X] have not been made and will no	ot be made.	
8. [] A translation of the amendments to	the claims under PCT Article 19 (35 U.S.C. 371(c)	0(3)).
9. [X] An oath or declaration of the inventor(s)	(35 U.S.C. 371 (c)(4)).	
10. [] A translation of the annexes to the I (35 U.S.C. 371(c)(5)).	nternational Preliminary Examination Report unde	r PCT Article 36
Items 11. to 16. below concern document(s) or	information included:	./A
	der 37 CFR 1.97 and 1.98., Form 1449, 9 Reference	
12. [X] An assignment document for recording.	A separate cover sheet in compliance with 37 CFF	3.28 and 3.31 is included.
13. [X] A FIRST preliminary amendment., Mark	xed Up Claims Page 27 eliminary amendment.	
14. [] A substitute specification.		
15. [] A change of power of attorney and		
16. [X] Other items or information: Front Page of English Translation of PCT/JP00/04613, Certification	of PCT/JP00/04613, PCT/ISA/210, PCT/IB/304, PCT/ n of Translation of the same.	IB/308, PCT/IB/332, WO-SS2000-3, PCT/IPEA/409,
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531 Rec'd PCT/FT 11 JAN 2002

ILS ABPLICATION NO. (If know	n. Se SECTEVISION TO A	INTERNATIONAL APPLICATION N	10	ATTORNEY'S DOCKET NUMBER		
UNKNOWN	10 70308	PCT/JP00/04613		10921.111USWO		
17. [X] The following fees are submitted:		CALCULATIONS PI	TO USE ONLY			
BASIC NATIONAL FI	EE (37 CFR 1.492(a) (1)-(5 been prepared by the EPO o)): r JPO	\$890.00			
International prelim (37 CFR 1.492(a)(ninary examination fee paid (o USPTO	\$710.00			
No international pre but international se	eliminary examination fee pa arch fee paid to USPTO (37	uid to USPTO (37 CFR 1.48 CFR 1.445(a)(2))	(2) \$740.00			
Neither international international search	al preliminary examination f n fee (37 CFR 1.445(a)(3)) p	ee (37 CFR 1.482) nor aid to USPTO	\$1040.00			
International prelim and all claims satis	ninary examination fee paid fied provisions of PCT Artic	to USPTO (37 CFR 1.482)	\$100.00			
	ENTER APPROP	RIATE BASIC FEE	AMOUNT =	\$90.00		
Surcharge of \$130.00 for months from the earliest	or furnishing the oath or decl claimed priority date (37 C	aration later than [] 20 [] . FR 1.492(e)).	30	\$0		
CLAIMS	NUMBER FILED	NUMBER EXTRA	RATE			
Total claims	24 -20=	0	X \$18.00	\$0		
Independent claims	1 -3 =	0	X \$84.00	\$0		
MULTIPLE DEPENDE	ENT CLAIM(S) (if applicab		+ \$260.00	S0		
	TOTAL	OF ABOVE CALCU	LATIONS =	\$890.00		
Reduction by 1/2 for filing by small entity, if applicable. Small entity status is claimed pursuant to 37 CFR 1.27			\$0			
n		S	UBTOTAL =	\$890.00		
Processing fee of \$130.0 months from the earliest	00 for furnishing the English t claimed priority date (37 C	translation later than [] 20 FR 1.492(f).	[]30	S0		
ii.		TOTAL NATIO	NAL FEE =	\$890.00		
Fee for recording the en accompanied by an app	closed assignment (37 CFR ropriate cover sheet (37 CFR	1.21(h)). The assignment r 3.28, 3.31). \$40.00 per pr	nust be operty +	\$40.00		
		TOTAL FEES E	NCLOSED =	\$930.00		
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				charged	S0	
b. [] Please charge	e amount of \$890.00 and \$ my Deposit Account No ppy of this sheet is enclosed.			to cover the abo	ve fees.	
c. [X] The Commiss overpayment	ioner is hereby authorized to to Deposit Account No. 13-2	charge any additional fees 2725.	which may be rec	quired, or credit any		
NOTE: Where an app 1.137(a) or (b)) must b	propriate time limit under pe filed and granted to rest	37 CFR 1.494 or 1.495 ha ore the application to pen	s not been met, a ding status.	petition to revive (37 CF)	R	
SEND ALL CORRESPONDENC Douglas P. Mueller MERCHANT & GO			SIG	gnature:	1	
P.O. Box 2903 Minneapolis MN 5						
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10/650845 PATENT #

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Araki, et al.

Docket No.:

10921.111USWO

Serial No.:

unknown

Filed:

concurrent herewith

Int'l Appln No.:

PCT/JP00/04613

Int'l Filing Date:

July 10, 2000

Title:

PROCESS FOR PRODUCING ADHESIVE FOR FUSION BONDING,

ADHESIVE FOR FUSION BONDING OBTAINED BY THE PROCESS, AND ADHESIVE FABRIC CONTAINING THE ADHESIVE FOR FUSION

BONDING

CERTIFICATE UNDER 37 CFR 1.10

'Express Mail' mailing label number: EL669944227US Date of Deposit: January 11, 2002

I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office To Addressee' service under 37 CFR 1.10 and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

By: Name: Chris Stordahl

PRELIMINARY AMENDMENT

Box PCT Assistant Commissioner for Patents Washington, D. C. 20231

Dear Sir:

In connection with the above-identified application filed herewith, please enter the

following preliminary amendment:

IN THE ABSTRACT

Insert the attached Abstract page into the application as the last page thereof.

IN THE SPECIFICATION

A courtesy copy of the present specification is enclosed herewith. However, the World Intellectual Property Office (WIPO) copy should be relied upon if it is already in the U.S.

Patent Office.

IN THE CLAIMS

Please amend the claims as follows:

- 11. A heat-fusion bonding adhesive prepared by the manufacturing method defined in claim $1. \ \,$
- 12. An adhesive fabric obtained by coating, on a surface of a base fabric, the heat-fusion bonding adhesive prepared by the manufacturing method defined in claim 1, and then thermally fusing the adhesive.

REMARKS

The above preliminary amendment is made to remove multiple dependencies from claims 11 and 12. Please refer to the Marked-Up claim page 27, attached herewith.

A new abstract page is supplied to conform to that appearing on the publication page of the WIPO application, but the new Abstract is typed on a separate page as required by U.S. practice.

Applicants respectfully request that the preliminary amendment described herein be entered into the record prior to calculation of the filing fee and prior to examination and consideration of the above-identified application.

If a telephone conference would be helpful in resolving any issues concerning this communication, please contact Applicants' primary attorney-of record, Douglas P. Mueller (Reg. No. 30,300), at (612) 612.371.5237.

Respectfully submitted,

MERCHANT & GOULD P.C. Post Office Box 2903 Minneapolis, Minnesota 55402-0903

(612) 332-5300

Dated: January 11, 2002

DPM/rw

Douglas P. Mueller Reg. No. 30,300

23552

MARKED UP VERSION

ethylene glycol, diethylene glycol, polyethylene glycol, 1,4-butane diol, and 1,6-hexane diol.

- 11. A heat-fusion bonding adhesive prepared by the 5 manufacturing method defined in <u>claim 1</u> [any one of claims 1 to 10].
- 12. An adhesive fabric obtained by coating, on a surface of a base fabric, the heat-fusion bonding

 10 adhesive prepared by the manufacturing method defined in claim 1 [any one of claims 1 to 10], and then thermally fusing the adhesive.

10/030845

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Araki, et al.

10921.111USWO Docket:

PROCESS FOR PRODUCING ADHESIVE FOR FUSION BONDING, ADHESIVE FOR Title:

FUSION BONDING OBTAINED BY THE PROCESS, AND ADHESIVE FABRIC

CONTAINING THE ADHESIVE FOR FUSION BONDING

CERTIFICATE UNDER 37 CFR 1.10

'Express Mail' mailing label number: EL669944227US

Date of Deposit: January 11, 2002

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Chris Stordahl

BOX PATENT APPLICATION Commissioner for Patents

Washington, D.C. 20231

Sir:

We are transmitting herewith the attached:

Transmittal sheet, in duplicate, containing Certificate under 37 CFR 1.10.

National Stage PCT Patent Application: Spec. 24 pgs; 12 claims; Abstract 1 pgs. The fee has been calculated as shown below in the 'Claims as Filed' table.

Information Disclosure Statement, Form 1449, 9 Reference(s)

A signed Combined Declaration and Power of Attorney

Assignment of the invention to Sumitomo Seika Chemicals Co., Ltd., Recordation Form Cover Sheet

A check in the amount of \$890.00 to cover the Filing Fee

A check for \$40.00 to cover the Assignment Recording Fee.

Other: Preliminary Amendment, Marked Up Claims Page 27, Front Page of PCT/IP00/04613, PCT/ISA/210, PCT/IB/304, PCT/IB/308, PCT/IB/332, WO-SS2000-3, PCT/IPEA/409, English Translation of

PCT/JP00/04613, Certification of Translation of the same.

Return postcard

CLAIMS AS FILED				
Number of Claims Filed	In Excess of:	Number Extra	Rate	Fee
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TOTAL FILING FEE	HATTEE			\$890.00

Please charge any additional fees or credit overpayment to Deposit Account No. 13-2725. A duplicate of this sheet is enclosed.

MERCHANT & GOULD P.C. P.O. Box 2903, Minneapolis, MN 55402-0903

(612) 332-5300

Name: Douglas P. Mueller Reg. No.: 30,300 Initials: DPMueller/rw



(PTO TRANSMITTAL - NEW FILING)

IN THE UNITED STATES PATENT AND TRADEMARK

Applicant: Araki, et al. 531 Rec'd PCT/PT 11 JAN 2002

10921.111USWO Docket:

PROCESS FOR PRODUCING ADHESIVE FOR FUSION BONDING, ADHESIVE FOR Title:

FUSION BONDING OBTAINED BY THE PROCESS, AND ADHESIVE FABRIC

CONTAINING THE ADHESIVE FOR FUSION BONDING

CERTIFICATE UNDER 37 CFR 1.10

'Express Mail' mailing label number: EL669944227US

Date of Deposit: January 11, 2002

I hereby certify that this paper or fee is being deposited with the United States Postal Service 'Express Mail Post Office To Addressee' service under 37 CFR 1.10 and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

BOX PATENT APPLICATION Commissioner for Patents

Washington, D.C. 20231

We are transmitting herewith the attached:

Transmittal sheet, in duplicate, containing Certificate under 37 CFR 1.10.

National Stage PCT Patent Application: Spec. 24 pgs; 12 claims; Abstract 1 pgs. The fee has been calculated as shown below in the 'Claims as Filed' table.

✓ Information Disclosure Statement, Form 1449, 9 Reference(s)
 ✓ A signed Combined Declaration and Power of Attorney

Assignment of the invention to Sumitomo Seika Chemicals Co., Ltd., Recordation Form Cover Sheet

A check in the amount of \$890.00 to cover the Filing Fee

☐ A check for \$40.00 to cover the Assignment Recording Fee.
☐ Other: Preliminary Amendment, Marked Up Claims Page 27, Front Page of PCT/IP00/04613, PCT/ISA/210, PCT/IB/304, PCT/IB/308, PCT/IB/332, WO-SS2000-3, PCT/IPEA/409, English Translation of

PCT/JP00/04613, Certification of Translation of the same.

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CLAIMS AS FILED

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MULTIPLE DEPENDENT CLA	AIM FEE					\$0.00
TOTAL FILING FEE						\$890.00

Please charge any additional fees or credit overpayment to Deposit Account No. 13-2725. A duplicate of this sheet is enclosed.

MERCHANT & GOULD P.C. P.O. Box 2903, Minneapolis, MN 55402-0903

(612) 332-5300

Name: Donglas P. Mueller Reg. No.: 30,300 Initials: DPMueller/rw

(PTO TRANSMITTAL - NEW FILING)

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DESCRIPTION 10/050845

METHOD FOR MANUFACTURE OF HEAT-FUSION BONDING ADHESIVE, HEAT-FUSION BONDING ADHESIVE OBTAINED BY THIS METHOD,

AND ADHESIVE FABRIC USING SUCH HEAT-FUSION BONDING
ADHESIVE

TECHNICAL FIELD

The present invention relaters to a method for the manufacture of a heat-fusion bonding adhesive. Further, the present invention also relates to a heat-fusion bonding adhesive obtained by this method. Moreover, the present invention also relates to a heat-fusion bonding adhesive obtained by thermally fusing the heat-fusion bonding adhesive to the surface of a base fabric.

BACKGROUND ART

Base materials of various types have been provided with a variety of functional properties such as oil resistance, solvent resistance, chemical resistance, wear resistance, gas shielding ability, adhesive properties, and the like by coating a thermoplastic resin thereon and forming a coating film. Among them, adhesive fabrics obtained by using a fiber-containing cloth or nonwoven fabric as a base fabric and coating a thermoplastic resin on the surface of the base fabric have been used mainly as adhesive interlinings in the field of clothing.

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For example, Japanese Patent Application Laid-open disclosed an adhesive interlining H6-145413 following method. First. fabricated by the composition prepared by adding silica and a silane 5 coupling agent to an acrylic polymer emulsion such as acrylate resin was coated on a fiber-containing nonwoven fabric serving as a base fabric and dried. Then, a powder of a thermoplastic resin such as a polyamide resin, polyester resin, polyethylene resin, ethylene-vinyl acetate resin, polyvinyl chloride resin, and the like was scattered over the coating and melted to obtain an adhesive interlining.

A variety of methods such as a scattering method, powder dot method, spray method, paste dot method, double dot method, and the like are employed for heating and fusing the thermoplastic resin powder to the base fabric surface, and the appropriate method is selected according to the type of base fabric. With the scattering method, a thermoplastic resin powder is uniformly scattered over the base fabric surface, heated, and fused. With the powder dot method, thermoplastic resin powder is first caused to adhere to a gravure roll, then transferred to the base fabric surface, heated, and fused. With the spray method, a paste prepared by dispersing a thermoplastic resin powder in water is sprayed as-is on the base fabric surface, thermally dried, and fused. With the paste dot method, a paste prepared by dispersing a thermoplastic

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resin powder in water is dot-like coated on the base fabric surface by using a coating screen having fine holes, thermally dried, and fused. The double dot method comprises the steps of dot-like coating an acrylic emulsion on the base fabric surface by using a having fine holes, scattering a coating screen thermoplastic resin powder over the obtained dot-like coating, removing the excess thermoplastic resin powder, and thermally drying and fusing the thermoplastic resin powder remaining on the base fabric. The thermoplastic resin powder thermally fused to the base fabric surface by those methods is used as a heat-fusion bonding adhesive and thermally fuses the base fabric to a surface fabric when reheated during usage.

adhesive fabrics, in particular, Adhesive interlinings mainly serve to supplement the properties of the surface fabrics in order to give a final threedimensional touch to a dress, to facilitate sewing and also to provide shape stability so as to prevent loss of shape in wearing or washing and dry cleaning. They are usually used for collars, cuffs, lapels of men's business suits, women's suits and the like and the required properties thereof differ depending on the application and place where they are used. For this reason, the optimum adhesive interlining is selected upon consideration of various conditions such as the type of thermoplastic resin powder, heat sealing method, type of base fabric, and the like.

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The thermoplastic resin powder can be prepared by a mechanical grinding method by which a thermoplastic resin such as a copolyamide resin, copolyester resin, ethylene-vinyl acetate copolymer resin, polyethylene resin, polyurethane resin, and the like is mechanically ground at normal temperature, or by a freeze grinding method by which grinding is conducted under freezing.

In recent years, in addition to the abovementioned application to women's suits, thin cloths for women have been actively developed and a need has increased for adhesive interlinings which do not degrade aesthetic shaping ability that provides feel and draping ability necessary to obtain beautiful silhouette and aesthetic functions especially required for clothing. However, when a thermoplastic resin powder is used as a hot-sealable adhesive, the resin powder is required to have a weight-average particle size of no more than 20µm if an adhesive interlining with a satisfactory feel is to be obtained. However, fine resin powder is very difficult manufacture by the mechanical grinding method or freeze grinding method.

Adhesive interlining prepared by thermally fusing a thermoplastic resin powder with relatively coarse particles having a size within a range of 60-500µm to the surface of a base fabric, for example, by a scattering method is typically used in clothing such as women's suits. However, if such an adhesive interlining

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is used for thin cloths, in particular, thin cloths for women, satisfactory feel is difficult to obtain. Thus, the cloths become rigid to the touch and problems are associated with their draping ability.

Furthermore, in the powder dot method, in order to improve powder separation when the powder is transferred from the gravure roll onto the base fabric, the base fabric has to be preheated to a temperature of 180-250°C. Certain basic fabrics are shrunk by such preheating and the feel thereof is degraded.

On the other hand, the paste dot method uses a paste of a resin powder with a comparatively small particle size within a range of 5-80µm, which somewhat improves the feel. However, though the particle size range is referred to as a 5-80µm range, the peak of particle size distribution within the range is actually shifted to a large size. As a result, the weight-average particle size is usually about 30-50µm, easily causing clogging of fine openings in the coating screen. For this reason, it is difficult to employ the screens with fine holes having a diameter of no more than 200µm. As a result, dot spacing is increased which results in a decreased adhesive force and degraded feel.

Furthermore, paste-like adhesives used in the 25 spray or paste dot method are manufactured by dispersing a thermoplastic resin powder in water. As a result, it is difficult to increase the resin

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concentration to more than 40wt%. Therefore, drying is time consuming and productivity is poor.

The double dot method resolves the above-described problems. With this method, a resin powder is scattered over an acrylic resin coating obtained by dot-like coating and the resin powder which adhered only to the zones coated with the acrylic resin is used as a hot-sealable adhesive. If the excess powdered resin is removed by suction after scattering, the resin powder should remain only on the acrylic resin dots. However, in reality, the powder cannot be completely removed by suction and the powder remaining outside the dots degrades the feel. Another problem is that the resin powder that adhered to the acrylic resin can peel therefrom, decreasing the adhesive strength.

DISCLOSURE OF THE INVENTION

It is an object of the present invention to provide a method for manufacturing a heat-fusion bonding adhesive suitable for obtaining adhesive interlinings which do not degrade the feel of the clothing, maintain shape stability, and demonstrate sufficient draping ability even when the adhesive is used for thin cloths, in particular, thin cloths for women.

Another object of the present invention is to provide a heat-fusion bonding adhesive obtained by such manufacturing method.

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Still another object of the present invention is to provide an adhesive fabric obtained by heating and fusing such heat-fusion bonding adhesive to the surface of a base fabric.

In accordance with the first aspect of the present invention, a method is provided for manufacturing a heat-fusion bonding adhesive for thermally fusing a base fabric to a surface fabric, comprising the steps of heating a thermoplastic resin to a temperature of no less than the softening point of the resin and dispersing it in the softened state in an aqueous medium.

In accordance with the second aspect of the present invention, it provides a heat-fusion bonding adhesive consisting of the aqueous dispersion of a thermoplastic resin obtained by the above-described manufacturing method.

No specific limitation is placed on the thermoplastic resin used in accordance with the present invention. Examples of suitable resins include copolyamide resins, copolyester resins, ethylene-vinyl acetate copolymer resins, polyethylene resins, polyurethane resins, and the like. Those resins may be used individually or in a mixture thereof. When a thermoplastic resin is used in a heat-fusion bonding adhesive for the fabrication of an adhesive fabric, it is preferred that copolyamide resins, copolyester resins, and mixtures thereof be used because of their

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capability to maintain a good thin cloth feel and resistance to dry cleaning and washing.

No specific limitation is placed on copolyamide resins. Suitable examples include copolyamide resins comprising structural units of at least two types selected from the group consisting of $-[NH(CH_2),CO]-$, --[NH(CH2)6NHCO(CH2)8CO]-, [NH(CH₂)₆NHCO(CH₂)₄CO]-, $[NH(CH_2)_{10}CO]$ -, and $-[NH(CH_2)_{11}CO]$ -. Specific examples include 6/66 copolymer nylon, 6/610 copolymer nylon, 6/11 copolymer nylon, 6/12 copolymer nylon, 6/66/610 copolymer nylon, 6/66/11 copolymer nylon, 6/66/12 6/66/11/12 copolymer nvlon, nvlon, copolymer polyamide copolymer nylon, and 6/66/610/11/12 elastomers which are the copolymers of those copolymer nylons and polyesters or polyalkylene ether glycols. Among them, 6/66/11 copolymer nylon, 6/66/12 copolymer nylon, and 6/66/11/12 copolymer nylon are preferred, and 6/66/12 copolymer nylon is especially preferred.

No specific limitation is placed on the copolyester resins. Examples of suitable copolyester resins include copolyester resins obtained by polycondensation of (A) an acid component comprising terephthalic acid and isophthalic acid and (B) a diol component such as ethylene glycol, diethylene glycol, polyethylene glycol, 1,4-butane diol or 1,6-hexane diol. Specific examples include terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin, terephthalic acid/isophthalic acid/isophthalic

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terephthalic acid/isophthalic acid/polyethylene glycol resin, terephthalic acid/isophthalic copolyester acid/ethylene glycol/1,4-butane diol copolyester resin, terephthalic acid/isophthalic acid/adipic acid/1.4butane diol copolyester resin, and terephthalic acid/isophthalic acid/1,4-butane diol/diethylene glycol Among them, terephthalic copolyester resin. acid/isophthalic acid/1,4-butane diol copolyester resin, terephthalic acid/isophthalic acid/ethylene glycol/1,4butane diol copolyester resin, and terephthalic 10 acid/isophthalic acid/1,4-butane diol/diethylene glycol copolyester resin are preferred, and terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin is especially preferred.

In the manufacturing method in accordance with the present invention, the thermoplastic resin can be agueous medium by heating the dispersed in an thermoplastic resin to a temperature of no less than the softening point thereof to obtain a softened state and then applying a shear force to the aqueous medium. In this process, the thermoplastic resin preheated to a temperature of no less than the softening point thereof may be added to the similarly heated aqueous medium under stirring, or the thermoplastic resin may be added to the aqueous medium under stirring and then heated together with the aqueous medium to a temperature of no less than the softening point thereof. Furthermore, when the thermoplastic resin is an ethylene-vinyl

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acetate copolymer resin, a polyethylene resin which is not terminated with a functional group, and the like, a surfactant or a dispersing agent may be added, if necessary, to the aqueous medium to accelerate the dispersion process. Furthermore, when the thermoplastic resin is a copolyamide resin or copolyester resins terminated with a carboxyl group, a basic substance may be added to the aqueous medium in addition to or instead of the surfactant or dispersing agent.

Examples of the surfactants include anionic surfactants (for example, rosin acid salts, fatty acid salts, alkylbenzenesulfonates), cationic surfactants (for example, dodecyltrimethylammonium chloride), nonionic surfactants (for example, ethylene oxide-propylene oxide block copolymer, polyoxyethylene alkyl ethers, glycerin fatty acid esters, polyoxyethylene fatty acid ethanolamides), amphoteric surfactants (for example, N-alkyl-N,N-dimethylammonium betaine).

Examples of dispersing agents include polymer

20 dispersing agents such as polyacrylic acid salts,
polystyrenesulfonic acid salts, polystyrene maleic
anhydride salts, polyvinyl alcohol, hydroxyethyl
cellulose, and the like, and inorganic dispersing
agents such as alumina sol, silica sol, calcium

25 phosphate, and the like.

Examples of basic substances include alkali metal hydroxides, such as sodium hydroxide or potassium hydroxide, ammonia, and amines. From the standpoint of

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dispersing effect, alkali metal hydroxides such as sodium hydroxide or potassium hydroxide are preferred.

In the manufacturing method in accordance with the present invention, good results are obtained if 5 dispersing of the thermoplastic resin in the aqueous medium is conducted at a temperature of no less than the softening point thereof, usually, at 50-300°C, preferably, 70-220°C. When the temperature is less than 50°C , softening of the thermoplastic resin in the medium is insufficient and, therefore. homogeneous dispersion cannot be obtained. When the temperature is higher than 300°C, the thermoplastic resin is degraded which is undesirable.

Furthermore, the amount of the aqueous medium used in the manufacturing method in accordance with the present invention is usually 30-1500 weight parts, preferably, 100-500 weight parts per 100 weight parts of thermoplastic resin. If the amount of water used is less than 30 weight parts, the thermoplastic resin cannot be completely dispersed in water, and if the amount is above 1500 weight parts, the concentration of the obtained aqueous dispersion thermoplastic resin is low which is undesirable for usage.

In the manufacturing method in accordance with the present invention, the weight-average particle size of aqueous dispersion οf particles in the resin thermoplastic resin can be randomly adjusted, example, by controlling heating or stirring conditions.

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It is usually adjusted to 0.1-20µm, preferably, 0.1-10um. If the weight-average particle size of resin particles in the aqueous dispersion of thermoplastic resin is less than 0.1µm, the particles cohere and 5 gelling easily occurs. As a result, a high resin concentration is difficult to obtain. If the weightaverage particle size of resin particles in the aqueous dispersion of thermoplastic resin is more than 20µm, fine holes in the screen used for coating are easily clogged and the adhesive force of the base fabric is decreased or the feel is degraded which is undesirable.

The heat-fusion bonding adhesive in accordance with the present invention is usually used upon compounding a viscosity-adjusting agent and adjusting the viscosity to 5000-50,000mPa·sec. If the viscosity is less than 5000mPa·sec, the amount infiltrated into the base fabric becomes too high, the fabric feels rigid, and the formation of dots is insufficient. If the viscosity is higher than 50,000mPa·sec, coating on the base fabric becomes difficult.

The compounded amount of the viscosity-adjusting agent is usually 0.01-5 weight parts based on 100 weight parts of the aqueous dispersion of thermoplastic resin, so as to obtain the above-described viscosity range. Examples of viscosity-adjusting agents include natural or synthetic polymeric thickening agents such as polyacrylamides, sodium polyacrylate, carboxymethyl cellulose, carboxyethyl cellulose, hydroxyethyl

cellulose, polyacrylic acid esters, polyethylene oxide, and ethylene oxide-propylene oxide random copolymer. If necessary, a plasticizer, a dispersing enhancer, an antifoaming agent, a softening agent, a stabilizer, and the like may be also compounded.

Furthermore, the concentration of the obtained aqueous dispersion of thermoplastic resin may be randomly adjusted by using an appropriate concentration means, for example, by using a semipermeable membrane. Alternatively, the aqueous dispersion of thermoplastic resin can be used after finely powdering it with drying means, for example, by conducting spray drying of the aqueous dispersion of thermoplastic resin (with or without concentration) as is or upon solid-liquid separation by a centrifugal separation process or by filtration.

In accordance with the third aspect of the present invention, it provides an adhesive fabric obtained by coating the hot-sealable adhesive on the surface of a base fabric and thermally fusing. The adhesive fabric thus obtained can be advantageously used, in particular, as an adhesive interlining which does not degrade the feel of thin cloth.

No specific limitation is placed on the base 25 fabric used as the adhesive fabric in accordance with the present invention. Thus, cloths or nonwoven fabrics using various fiber materials can be used. Examples of fiber materials include natural fibers such as cotton,

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hemp, silk, wool, and the like, regenerated fibers such as rayon, cupra, and the like, semisynthetic fibers acetate, triacetate, and the like, such as synthetic fibers such as polyesters, nylon, acryl, urethane. polypropylene, polyethylene, polyvinyl chloride, and the like. Examples of woven fabrics include fabrics or cloths produced from the fiber materials, and examples of nonwoven fabrics include webs in which fiber materials are interwoven by 10 chemical methods, mechanical methods, or combinations thereof.

No specific limitation is placed on the method for coating the heat-fusion bonding adhesive on the base fabric. However, since the heat-fusion bonding adhesive in accordance with the present invention is obtained as an aqueous dispersion, the especially preferred results are obtained when it is thermally fused to the base fabric surface by the paste dot method. With the paste dot method, a heat-fusion bonding adhesive is introduced into a rotary screen having a plurality of fine holes and extruded onto a base fabric through the fine holes of the rotary screen to obtain a dot-like coating.

The diameter of fine holes in the rotary screen is
usually about 200µm. Utilizing the heat-fusion bonding
adhesive in accordance with the present invention makes
it possible to use a screen with a mesh size of about
50-200µm. Furthermore, the dot density is usually 50-

120 dots/cm² of base fabric, but utilizing the heat-fusion bonding adhesive in accordance with the present invention makes it possible to obtain a coating with a maximum of about 4000 dots/cm². The coating weight is usually 10-20g/m², but utilizing the heat-fusion bonding adhesive in accordance with the present invention makes it possible to obtain a sufficient adhesive force even at a coating weight of no more than 5g/m², the result depending on the type of base fabric.

If the base fabric is heated to a temperature of 80-150°C upon coating the heat-fusion bonding adhesive on the base fabric, the heat-fusion bonding adhesive is dried, melted, and fused to the base fabric, producing the target adhesive fabric. The obtained adhesive fabric can be adhesively bonded, for example, as an adhesive interlining, with an iron or a hot press to a variety of different surface fabrics, providing for a very good finish feel when used for thin cloth, in particular, thin cloth for women.

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BEST MODE FOR CARRYING OUT THE INVENTION

The present invention will be described below in greater details based on examples thereof and comparative examples. The present invention is, however, not limited to those examples.

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(Example 1 : Preparation of aqueous dispersion of thermoplastic resin)

total of 150 kg of 6/66/12 copolvamide (softening point 130°C), 149.6kg of water, and 0.4kg of sodium hydroxide were charged and sealed in a pressureresistant autoclave equipped with a jacket, having an inner diameter of 700mm, a height of 1500mm, and an inner capacity of 0.45m3, and provided with a turbinetype stirring impeller with a diameter of 350mm. The stirrer was then activated and the temperature inside the autoclave was raised to 150°C by circulating a heated oil in the jacket, while conducting stirring at a rate of 150 revolutions per minute. The stirring was further conducted for 30 minutes, while the internal temperature was maintained at 150°C. Then, the contents was cooled to 50°C and an aqueous dispersion of 6/66/12 copolyamide resin with a resin concentration of 50wt%. was obtained.

The weight-average particle size of the obtained aqueous dispersion of 6/66/12 copolyamide resin was measured with a particle size measurement apparatus of a laser diffraction type (manufactured by Shimadzu Corporation, model SALD 2000); the weight-average particle size was 1.2µm.

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(Example 2 : Preparation of aqueous dispersion of thermoplastic resin)

A total of 150kg of terephthalic acid/isophthalic acid/1,4-butane diol copolyester (softening point 90°C). 120kg of water, and 30kg of ethylene oxide - propylene oxide block copolymer as a surfactant were charged and sealed in a pressure-resistant autoclave equipped with a jacket, having an inner diameter of 700mm, a height of 1500mm, and an inner capacity of 0.45m3, and 10 provided with a turbine-type stirring impeller with a diameter of 350mm. The stirrer was then activated and the temperature inside the autoclave was raised to 150°C by circulating a heated oil in the jacket, while conducting stirring at a rate of 150 revolutions per minute. The stirring was further conducted for 30 15 minutes, while the internal temperature was maintained at 150°C. Then, the contents was cooled to 50°C and an aqueous dispersion of terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin with a resin 20 concentration of 50wt% was obtained.

The weight-average particle size of the obtained aqueous dispersion of terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin was measured with a particle size measurement apparatus of a laser diffraction type (manufactured by Shimadzu Corporation, model SALD 2000); the weight-average particle size was 2.5µm.

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(Example 3 : Fabrication of adhesive fabric)

A total of 0.2 weight parts of sodium polyacrylate was added to 100 weight parts of the aqueous dispersion of 6/66/12 copolyamide resin obtained in Example 1 and a paste-like heat-fusion bonding adhesive with a viscosity of 22,000mPa·sec was obtained.

The obtained heat-fusion bonding adhesive was dotlike coated on the surface of a nylon nonwoven fabric with a weight of 25g/m² by using a screen with a fine 10 hole diameter of 80µm. The dot density was 300 dots/cm² and the coating weight was 5g/m². The adhesive fabric was then obtained by drying and fusing for 1 minute at a temperature of 150°C.

15 (Example 4 : Fabrication of adhesive fabric)

A total of 0.2 weight parts of sodium polyacrylate was added to 100 weight parts of the aqueous dispersion of terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin obtained in Example 2 and a pastelike heat-fusion bonding adhesive with a viscosity of 20.000mPa·sec was obtained.

The obtained heat-fusion bonding adhesive was dotlike coated on the surface of a polyester nonwoven fabric with a weight of $25g/m^2$ by using a screen with a fine hole diameter of $80\mu m$. The dot density was 300dots/cm² and the coating weight was $5g/m^2$. The adhesive fabric was then obtained by drying and fusing for 1 minute at a temperature of 150°C .

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(Example 5 : Fabrication of adhesive fabric)

A total of 0.2 weight parts of sodium polyacryalte was added to a liquid mixture of 50 weight parts of the aqueous dispersion of 6/66/12 copolyamide resin obtained in Example 1 and 50 weight parts of the aqueous dispersion of terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin obtained in Example 2 and a paste-like heat-fusion bonding adhesive with a viscosity of 20.000mPa·sec was obtained.

The obtained heat-fusion bonding adhesive was dot-like coated on the surface of a nylon nonwoven fabric with a weight of $25g/m^2$ by using a screen with a fine hole diameter of $80\mu m$. The dot density was 300 dots/cm^2 and the coating weight was $5g/m^2$. The adhesive fabric was then obtained by drying and fusing for 1 minute at a temperature of $150\,^{\circ}\text{C}$.

(Example 6 : Fabrication of adhesive fabric)

A total of 1 weight part of polyethylene oxide

20 (trade name PEO-18, manufactured by Sumitomo Seika

Chemicals Co., Ltd.) was added to a liquid mixture of

90 weight parts of the aqueous dispersion of 6/66/12

copolyamide resin obtained in Example 1 and 10 weight

parts of ethylene-vinyl acetate copolymer emulsion

25 (trade name Sepolsion V, manufactured by Sumitomo Seika

Chemicals Co., Ltd.) and a paste-like heat-fusion

bonding adhesive with a viscosity of 23,000mPa·sec was

obtained.

The obtained heat-fusion bonding adhesive was dotlike coated on the surface of a nylon nonwoven fabric with a weight of 25g/m² by using a screen with a fine hole diameter of 80µm. The dot density was 300 dots/cm2 5 and the coating weight was 5g/m2. The adhesive fabric was then obtained by drying and fusing for 1 minute at a temperature of 150°C.

(Comparative Example 1)

- A 6/66/12 copolyamide resin (softening temperature 130°C) was frozen, ground and then classified through a standard sieve with a mesh size of 80um to obtain a 6/66/12 copolyamide resin powder with a weight-average particle size of 45µm. A total of 64.8 weight parts of 15 water and 0.2 weight parts of sodium polyacryalte were added to 35 weight parts of the obtained 6/66/12 copolyamide resin powder and the components were stirred to obtain a paste-like heat-fusion bonding adhesive with a viscosity of 23,000mPa·sec.
- 20 The obtained heat-fusion bonding adhesive was dot-like coated on the surface of a nylon nonwoven fabric with a weight of $25g/m^2$ at a dot density of 300 dots/cm² and a coating weight of 5g/m2 by using a screen with a fine hole diameter of 80µm. However, the screen
- 25 partially clogged and dot-like coating was impossible.

(Comparative Example 2)

A 6/66/12 copolyamide resin (softening temperature 130°C) was frozen, ground and then classified through a standard sieve with a mesh size of 80µm to obtain a 6/66/12 copolyamide resin powder with a weight-average particle size of 45µm. A total of 64.8 weight parts of water and 0.2 weight parts of sodium polyacryalte were added to 35 weight parts of the obtained 6/66/12 copolyamide resin powder and the components were stirred to obtain a paste-like heat-fusion bonding adhesive with a viscosity of 23,000mPa·sec.

The obtained heat-fusion bonding adhesive was dotlike coated on the surface of a nylon nonwoven fabric
with a weight of 25g/m² at a dot density of 150

15 dots/cm² and a coating weight of 10g/m² by using a
screen with a fine hole diameter of 200µm. The adhesive
fabric was then obtained by drying and fusing for 2
minutes at a temperature of 150°C.

20 (Comparative Example 3)

A terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin (softening temperature 90°C) was frozen, ground and then classified through a standard sieve with a mesh size of 80µm to obtain a terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin powder with a weight-average particle size of 42µm. A total of 64.8 weight parts of water and 0.2 weight parts of sodium polyacrylate were added to 35 weight

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parts of the obtained terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin powder and the components were stirred to obtain a paste-like heat-fusion bonding adhesive with a viscosity of 22.000mPa·sec.

The obtained heat-fusion bonding adhesive was dot-like coated on the surface of a polyester nonwoven fabric with a weight of $25g/m^2$ at a dot density of 300 dots/cm² and a coating weight of $5g/m^2$ by using a screen with a fine hole diameter of $80\mu m$. However, the screen was partially clogged and dot-like coating was impossible.

(Comparative Example 4)

A terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin (softening temperature 90°C) was frozen, ground and then classified through a standard sieve with a mesh size of 80µm to obtain a terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin powder with a weight-average particle size of 42µm. A total of 64.8 weight parts of water and 0.2 weight parts of sodium polyacrylate were added to 35 weight parts of the obtained terephthalic acid/isophthalic acid/1,4-butane diol copolyester resin powder and the components were stirred to obtain a paste-like heatfusion bonding adhesive with a viscosity of 23,000mPa·sec.

The obtained heat-fusion bonding adhesive was dot-like coated on the surface of a polyester nonwoven fabric with a weight of 25g/m² at a dot density of 150 dots/cm² and a coating weight of 10g/m² by using a screen with a fine hole diameter of 200µm. The adhesive fabric was then obtained by drying and fusing for 2 minutes at a temperature of 150°C.

(Evaluation)

10 Feel of the adhesive fabrics obtained in Examples 3-6 and Comparative Examples 1-4 was evaluated by the following method. The results are shown in Table 1.

FEEL EVALUATION METHOD

15 Evaluation was conducted by a functional test based on the following criteria:

① : softness of cloth is fully maintained.

 \triangle : feels slightly stiff.

× : stiff.

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TABLE 1

No.	Feel Evaluation
Example 3	0
Example 4	0
Example 5	0
Example 6	0
Comparative Example 1	-
Comparative Example 2	$\triangle \sim \times$
Comparative Example 3	-
Comparative Example 4	△~×

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As described above, in Examples 3~6 of the present invention, the thermoplastic resin in the medium (heat-fusion bonding adhesive) had a weightaverage particle size of 0.1-20µm and was dispersed uniformly. Therefore, when coating is conducted by the paste dot method, screen clogging hardly occurs and the adhesive can be coated on the surface of a basic fabric in the form of small dots and with a high density. As a result, when the obtained adhesive fabric is used as an adhesive interlining of thin cloths, in particular, thin cloths for women, excellent characteristics can be provided. Thus, aesthetic shaping ability which provides feel and draping ability necessary to obtain beautiful silhouette and aesthetic functions required for clothing is not degraded. By contrast, comparative Examples 1~4, the heat-fusion bonding adhesive could not be coated on a basic fabric, or even when it could be coated, the feel was degraded.

CLAIMS

- 1. A method for manufacturing a heat-fusion bonding adhesive comprising the steps of heating a thermoplastic resin to a temperature of no less than a softening point of the resin, and dispersing the resin in the softened state in an aqueous medium to obtain an
- 10 2. The manufacturing method according to claim 1, wherein the dispersing of said thermoplastic resin in said aqueous medium is conducted by applying a shear force to said aqueous medium by stirring.

aqueous dispersion of the thermoplastic resin.

15 3. The manufacturing method according to claim 2, wherein the stirring of said aqueous medium is conducted till said thermoplastic resin is divided into particles with a weight-average particle diameter of 0.1-20um.

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4. The manufacturing method according to claim 1, wherein at least one of a surfactant, a dispersing agent, and a basic substance is added to said aqueous medium.

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5. The manufacturing method according to claim 1, wherein said thermoplastic resin is softened by being heated to a temperature of 50-300°C.

6. The manufacturing method according to claim 1, wherein the ratio of said aqueous medium is 30-1500 weight parts per 100 weight parts of said thermoplastic resin.

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7. The manufacturing method according to claim 1, wherein the viscosity of said aqueous medium is adjusted to 5000-50,000mPa·sec by the addition of a viscosity-adjusting agent.

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8. The manufacturing method according to claim 1, wherein said thermoplastic resin is selected from the group consisting of copolyamide resins, copolyester resins, and mixtures thereof.

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9. The manufacturing method according to claim 8, wherein said copolyamide resin has structural units of at least two types selected from the group consisting of $-[NH(CH_2)_2CO]_-$, $-[NH(CH_2)_6NHCO(CH_2)_4CO]_-$, $-[NH(CH_2)_6NHCO(CH_2)_8CO]_-$, and $-[NH(CH_2)_{11}CO]_-$.

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10. The manufacturing method according to claim 8, wherein said copolyester resin is a resin obtained by 25 polycondensation of an acid component comprising terephthalic acid and isophthalic acid and a diol component selected from the group consisting of

ethylene glycol, diethylene glycol, polyethylene glycol, 1,4-butane diol, and 1,6-hexane diol.

- 11. A heat-fusion bonding adhesive prepared by the 5 manufacturing method defined in any one of claims 1 to 10.
- 12. An adhesive fabric obtained by coating, on a surface of a base fabric, the heat-fusion bonding 10 adhesive prepared by the manufacturing method defined in any one of claims 1 to 10, and then thermally fusing the adhesive.

Declaration and Power of Attorney For Patent Application 特許出願宣言書

Japanese Language Declaration

私は、下欄に氏名を記載した発明者と り宣言する:	こして、以下のとお	As a below named inventor, I hereby declare that:
私の住所、郵便の宛先および国籍は、1 記載したとおりであり、	欄に氏名に続いて	\ensuremath{My} residence, post office address and citizenship are as stated below next to my name,
名称の発明に関し、請求の範囲に記載 題の本来の、最初にして唯一の発明者で のみが下欄に記載されている場合)か、 最初にして共同の発明者である(複数の されている場合)と信じ、	である(一人の氏名 もしくは本来の、	I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and join inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD FOR MANUFACTURE OF HEAT-FUSION
		BONDING ADHESIVE, HEAT-FUSION BONDING
		ADHESIVE OBTAINED BY THIS METHOD, AND
		ADHESIVE FABRIC USING SUCH HEAT-FUSION
		BONDING ADMESIVE
その明細書を (該当する方に印を付す)		the specification of which (check one)
□ここに添付する。		☐ is attached hereto.
(該当する場合)	-	□ was filed onas Application Serial No and was amended on(if applicable)
□ 目にP 第		Was described and claimed in PCT international application No. PCT/JP00/04613
77 PCT第19条に基づき		filed onJuly 10, 2000
(該当する場合		and as amended under PCT Article 19 or 34 on
		(if applicable)
私は、前記のとおり補正した請求の範 の内容を検討し、理解したことを陳述:		I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.
私は、連邦規則法典第37部第1章第569 願の審査に所要の情報を開示すべき義和 める。		I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37. Code of Faderal Regulations \$1.56(a)

page 1 of 4

Militaria des bases (1) (1) pri par.

Japanese Language Declaration

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PCT国際出願を以下に明記	する:	application on which priority is	claimed:	
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Patent Application No. 11-196969	Japan	12/07/1999	区 Yes あり	□ No なし
(Number) (番号)	(Country) (国名)	(Day/Month/Year Filed) (出願の年月日)		
			Yes	Ņo
(Number) (番号)	(Country) (国名)	(Day/Month/Year Filed) (出願の年月日)	あり	なし
	uq-u/	(14860-1111)	☐ Yes	□ No
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	(国名)	(出願の年月日)		
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	TE, No. 41.02.2 TE, No. 41.02.2 TE, No. 41.02.2 TE, No. 34.130 TE, No. 34.130 TE, No. 34.130 TE, No. 34.130 TE, No. 25.949 TE, No. 35.949 TE, No. 35.949 TE, No. 35.964 TE, No. 35.964 TE, No. 35.964 TE, No. 36.414 TE, No. 42.157 TE, No. 26.187 TE, No. 26.187 TE, No. 26.187 TE, No. 26.187 TE, No. 26.414 TE, No. 41.192 TE, No. 36.414 TE, No. 41.193 TE, No. 31.112 TE, No. 41.193 TE, No. 31.112 TE, No. 41.193 TE, No. 31.112 TE, No. 41.193 TE, No. 41.	Le No. 41,633 Karjeker, Shaukat Kastelik, Joseph M. Kastelik, Joseph M. Kenelberger, Densse Roy J. 24,64 Keys, Jeramie J. Kenelberger, Densse Keys, Jeramie J. Keys, Leramie J. Kowalchyk, Katherune M. Lacy, Paul A. Kowalchyk, Katherune M. Lacy, Paul A. Kowalchyk, Katherune M. Lacy, Paul A. Kowalchyk, Katherune M. Leon, Andrew J. Ew No. 15,968 Leonard, Chrusopher J. Liega, Mara E. Roy No. 18,074 Lindquist, Timothy A. Lycke, Lawrence E. Roy No. 26,079 McDonald, Daniel W. Key No. 28,070 McDonald, Daniel W. Key No. 28,070 McDonald, Daniel W. Key No. 18,042 McDonald, Daniel W. Michem M. Todd Key No. 18,084 Phillips, John B. Phillips, John B. Phillips, John B. Phillips, Bryan K. Phillips, Bryan K. Phillips, Bryan K.

Reg. No. 29,165	Qualey, Terry	Reg. No. 25,148
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Reg. No. 42,724	Spellman, Steven J.	Reg. No. 45,124
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Reg. No. P-46,990	Witt, Jonelle	Reg. No. 41,980
Reg. No. 37,206	Wu, Tong	Reg. No. 43,361
Reg. No. 37,209	Xu, Min S.	Reg. No. 39,536
Reg. No. 46,068	Zeuli, Anthony R.	Reg. No. 45,255
Reg. No. 37,209		

書類の送付先: Douglas P. Mueller MERCHANT & GOULD P.C. 3200 IDS Center, 80 South 8th Street, Minneapolis, MN 55402-2215, U.S.A. Send Correspondence to: Douglas P. Mueller MERCHANT & GOULD P.C. 3200 IDS Center, 80 South 8th Street, Minneapolis, MN 55402-2215, U.S.A

直通電話連絡先: (電話番号) Douglas P. Mueller at 612/371-5237 Direct Telephone Calls to: (telephone number) Douglas P. Mueller at 612/371-5237

唯一のまたは第一の発明者の氏名 一	Full name of sole or first inventor
唯一のよたは第一の元列目の氏目	Eiichi Araki
	Inventor's signature Date
司発明者の署名 日付	0 (. A / . Tanuary 7 2002
	Residence c/o Functional Polymers Research Laboratory,
生所	Sumitomo Seika Chemicals Co., Ltd.
	Sumitomo Seika Chemicals Co., Ltd. Himeji-shi, <u>Hyogo</u> , Japan <u>JPX</u>
国籍	Citizenship Japan
郵便の宛先	Post Office Address c/o Functional Polymers Research Laboratory,
	Sumitomo Seika Chemicals Co., Ltd.
	 Irifune-cho, Shikama-ku,
	Himeji-shi, Hyogo 672-8076 Japan
2-	Full name of second joint inventor, if any
第2の共同発明者の氏名(該当する場合) ~ ~	
	Norihiro Sugihara Second Inventor's signature Date
同第2発明者の署名 日付	Second inventor sugment
住所	Residence c/o Functional Polymers Research Laboratory, Sumitomo Seika Chemicals Co., Ltd.
	Himeji-shi, Hyogo, Japan
TA TOTAL CONTRACTOR OF THE PARTY OF THE PART	Citizenship Japan
郵便の宛先	Post Office Address c/o Functional Polymers Research Laboratory,
A-10	Sumitomo Seika Chemicals Co., Ltd.
	1, Irifune-cho, Shikama-ku,
	Himeji-shi, Hyogo 672-8076 Japan
2	Full name of third joint inventor, if any
第3の共同発明者の氏名(該当する場合)	
	Kaichiro Nakao
同第3発明者の署名 日付	Third Inventor's signature July 1, 2002
	glaiching Makao
住所	Residence c/o Functional Polymers Research Laboratory,
	Sumitomo Seika Chemicals Co., Ltd. Himeji-shi, Hyogo, Japan DX
国籍	Citizenship Japan
郵便の宛先	Post Office Address c/o Functional Polymers Research Laboratory,
3 DC 47676	Sumitomo Seika Chemicals Co., Ltd.
	 Irifune-cho, Shikama-ku,
	Himeji-shi, Hyogo 672-8076 Japan
第4の共同発明者の氏名(該当する場合) 4-	Full name of fourth joint inventor, if any
第4の共同光明者の以右(畝当する場合) 丁	Hiroshi Manabe
	Founds Inventor's cignatum Date
同第4発明者の署名 日付	Hiroshi Manake January 7, 2002
住所	Residence c/o Functional Polymers Research Laboratory,
	Sumitomo Seika Chemicals Co., Ltd. Himeji-shi, Hyogo, Japan JPX
国籍	Citizenship Japan
郵便の宛先	Post Office Address c/o Functional Polymers Research Laboratory
	Sumitomo Seika Chemicals Co., Ltd.
	1, Irifune-cho, Shikama-ku,
	Himeji-shi, Hyogo 672-8076 Japan
# 「の世回歌四本の氏々 (禁业ナス組合) 「	Full name of fifth Joint Inventor, if any
第5の共同発明者の氏名(該当する場合)	Tooru Takei
	Det
同第5発明者の署名 日付	Fifth Inventor's signature Date January 4, 2002
	for force
住所	Residence
	Sanda-shi, <u>Hyogo</u> , Japan JPX
国籍	Citizenship Japan
郵便の宛先	Post Office Address
野快り犯元	1-43-4. Yurinokidai, Sanda-shi,

1-43-4, Yurinokidai, Sanda-shi, Hyogo 669-1324 Japan